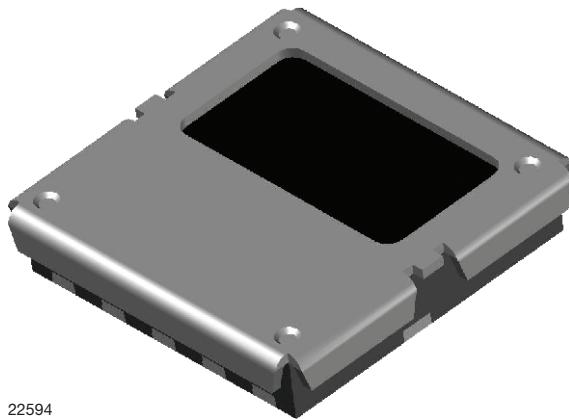


## IR Receiver Modules for Remote Control Systems



22594

### ORDERING CODE

#### Taping:

TSOP37...TT - top view taped

TSOP37...TR - side view taped

### FEATURES

- Very low supply current
- Photo detectors and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- Improved immunity against ambient light
- Insensitive to supply voltage ripple and noise
- External metal shield
- Material categorization:  
For definitions of compliance please see  
[www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
**HALOGEN FREE**  
**GREEN**  
(5-2008)

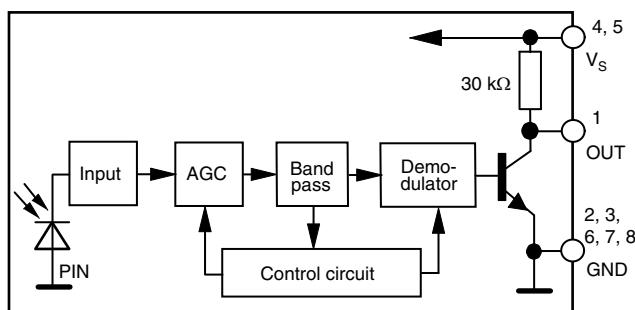
### DESCRIPTION

The TSOP373..H, TSOP375..H series are miniaturized receiver modules for infrared remote control systems. A PIN diode and a preamplifier are assembled on a PCB, the epoxy lens cap is designed as an IR filter.

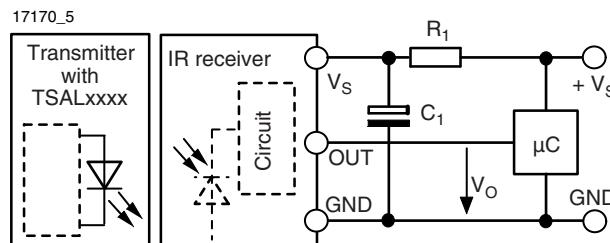
The demodulated output signal can be directly connected to a microprocessor for decoding. The TSOP373..H is optimized to better suppress spurious pulses from energy saving lamps. The TSOP375..H has an excellent noise suppression. It is immune to dimmed LCD backlighting and any fluorescent lamps. AGC3 and AGC5 may also suppress some data signals in case of continuous transmission.

This component has not been qualified according to automotive specifications.

<b>PARTS TABLE</b>			
AGC		NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)
Carrier frequency	36 kHz	TSOP37336H (1)(2)	TSOP37536H (1)(2)
	38 kHz	TSOP37338H (3)(4)(5)(6)	TSOP37538H (3)(4)(5)
	40 kHz	TSOP37340H	TSOP37540H
	56 kHz	TSOP37356H	TSOP37556H
Package		Belobog shield	
Pinning		1 = OUT; 2, 3, 6, 7, 8 = GND; 4, 5 = Vs	
Dimensions (mm)		4.3 W x 4.3 H x 1.0 D	
Mounting		SMD	
Application		Remote control	
Best remote control code		(1) MCIR (2) RCMM (3) Mitsubishi (4) RECS-80 Code (5) r-map (6) XMP-1, SMP-2	

**BLOCK DIAGRAM**


20445-5

**APPLICATION CIRCUIT**


$R_1$  and  $C_1$  are recommended for protection against EOS. Components should be in the range of  $33 \Omega < R_1 < 1 \text{ k}\Omega$ ,  $C_1 > 0.1 \mu\text{F}$ .

**ABSOLUTE MAXIMUM RATINGS**

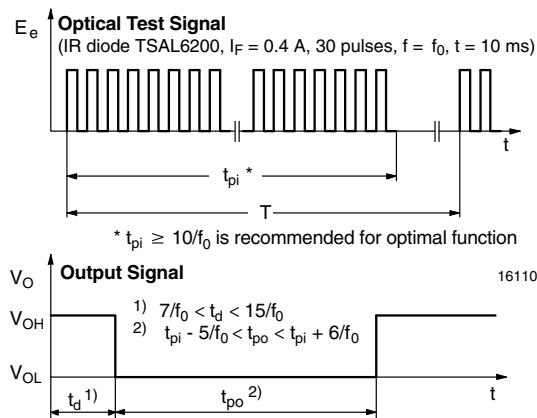
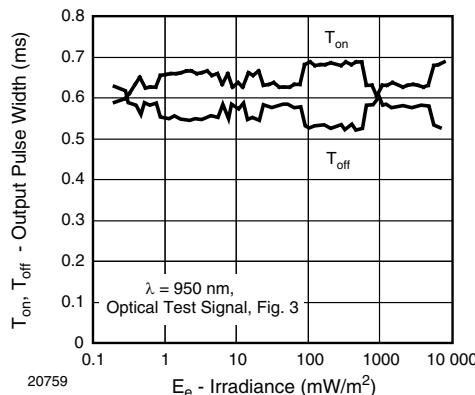
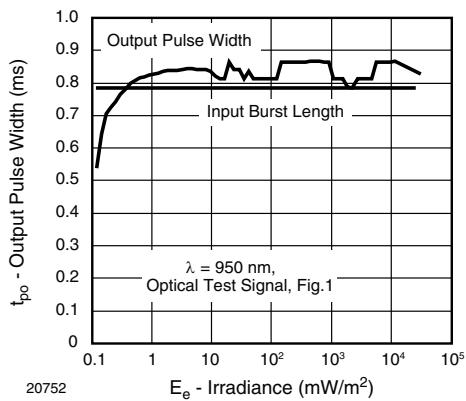
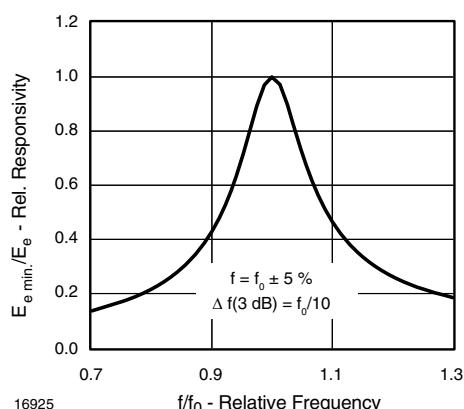
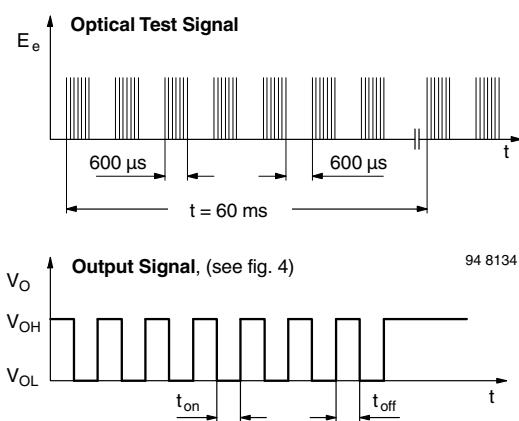
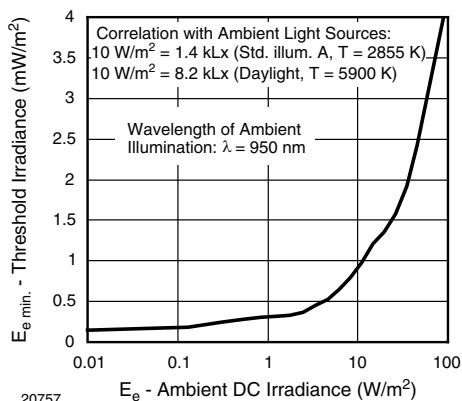
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		$V_S$	-0.3 to +6	V
Supply current		$I_S$	3	mA
Output voltage		$V_O$	-0.3 to $(V_S + 0.3)$	V
Output current		$I_O$	5	mA
Junction temperature		$T_J$	100	°C
Storage temperature range		$T_{stg}$	-25 to +85	°C
Operating temperature range		$T_{amb}$	-25 to +85	°C
Power consumption	$T_{amb} \leq 85 \text{ }^{\circ}\text{C}$	$P_{tot}$	10	mW

**Note**

- Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

**ELECTRICAL AND OPTICAL CHARACTERISTICS ( $T_{amb} = 25 \text{ }^{\circ}\text{C}$ , unless otherwise specified)**

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		$V_S$	2.5		5.5	V
Supply current	$V_S = 3.3 \text{ V}$ , $E_v = 0$	$I_{SD}$	0.27	0.35	0.45	mA
	$E_v = 40 \text{ klx}$ , sunlight	$I_{SH}$		0.45		mA
Transmission distance	$E_v = 0$ , IR diode TSAL6200, $I_F = 200 \text{ mA}$ , test signal see fig. 1	$d$		45		m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}$ , $E_e = 0.7 \text{ mW/m}^2$ , test signal see fig. 1	$V_{OSL}$			100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$ , test signal see fig. 1	$E_e \text{ min.}$		0.12	0.25	$\text{mW/m}^2$
Maximum irradiance	$t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$ , test signal see fig. 1	$E_e \text{ max.}$	30			$\text{W/m}^2$
Directivity	Angle of half transmission distance	$\phi_{1/2}$		$\pm 75$		deg

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)

**Fig. 1 - Output Function**

**Fig. 4 - Output Pulse Diagram**

**Fig. 2 - Output Pulse Width vs. Irradiance**

**Fig. 5 - Frequency Dependence of Responsivity**

**Fig. 3 - Output Function**

**Fig. 6 - Sensitivity in Bright Ambient**

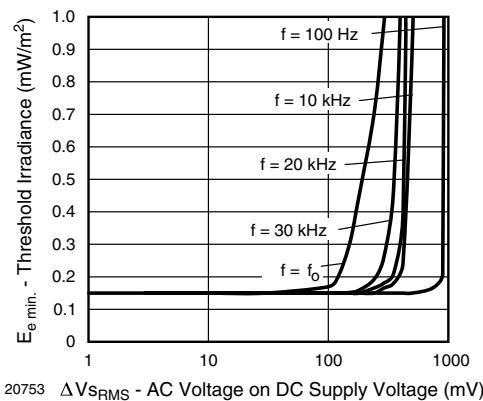

20753  $\Delta V_{S_{RMS}}$  - AC Voltage on DC Supply Voltage (mV)

Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

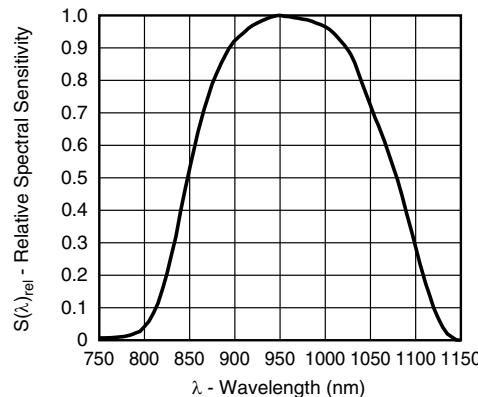


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

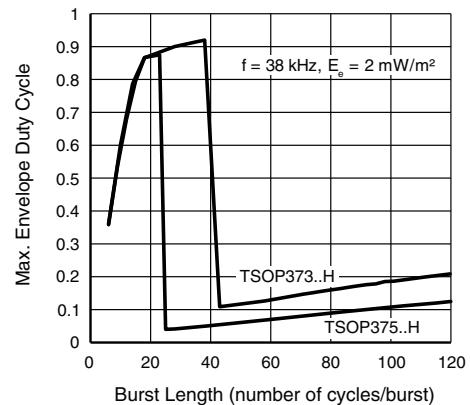


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

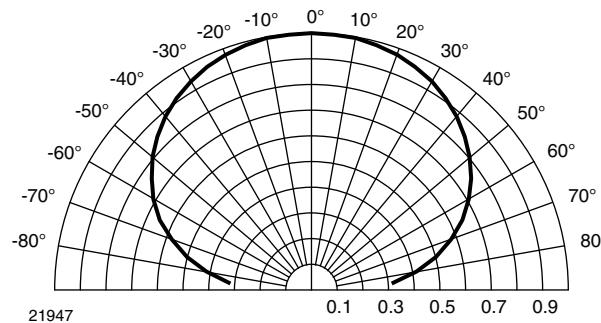


Fig. 11 - Directivity

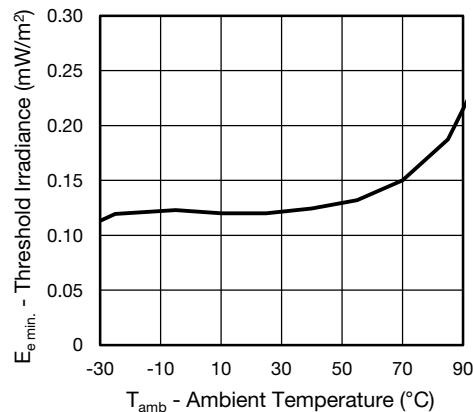


Fig. 9 - Sensitivity vs. Ambient Temperature

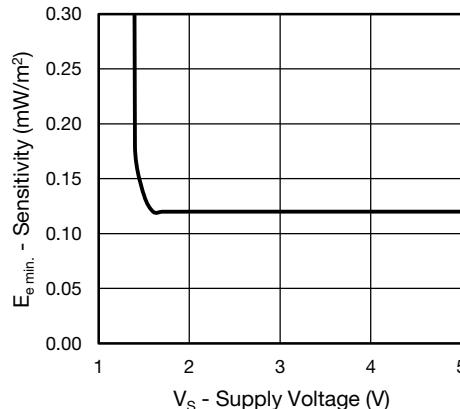


Fig. 12 - Sensitivity vs. Supply Voltage

## SUITABLE DATA FORMAT

The TSOP373..H, TSOP375..H series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP373..H, TSOP375..H in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see figure 12 or figure 13)

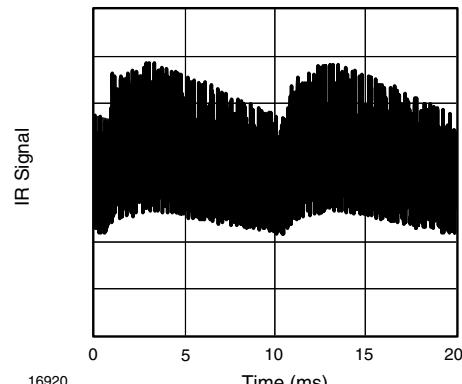


Fig. 13 - IR Signal from Fluorescent Lamp with Low Modulation

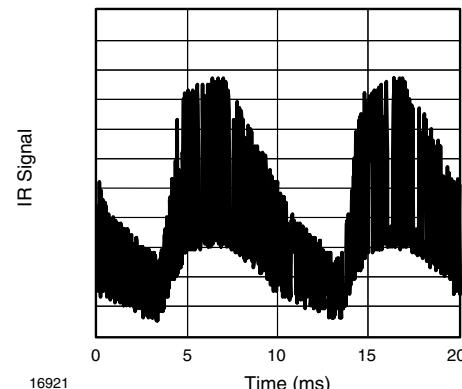


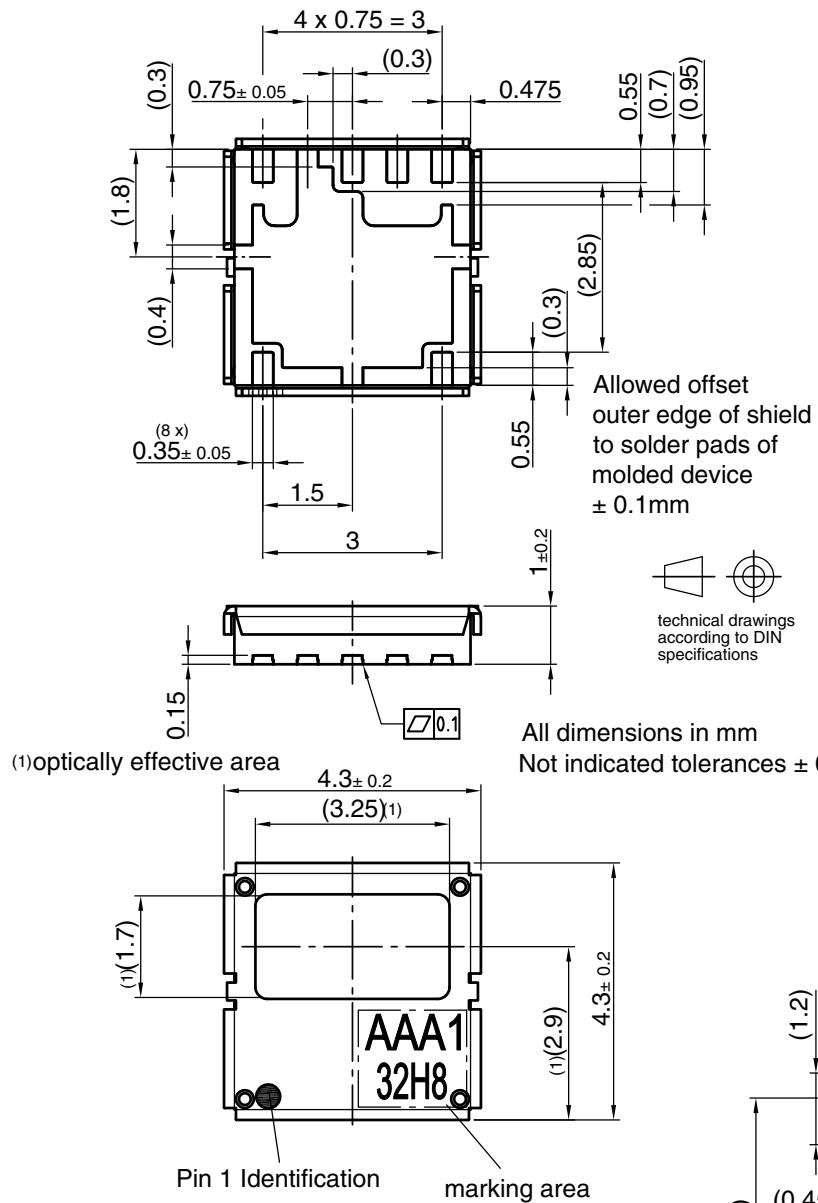
Fig. 14 - IR Signal from Fluorescent Lamp with High Modulation

	<b>TSOP373..H</b>	<b>TSOP375..H</b>
Minimum burst length	6 cycles/burst	6 cycles/burst
After each burst of length a minimum gap time is required of	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	35 cycles ≥ 6 x burst length	24 cycles ≥ 25 ms
Maximum number of continuous short bursts/second	2000	2000
MCIR code	preferred	yes
RCMM code	preferred	yes
XMP-1, XMP-2 code	preferred	yes
Suppression of interference from fluorescent lamps	Even critical disturbance signals are suppressed (example: signal pattern of fig. 12 and fig. 13)	Even critical disturbance signals are suppressed (example: signal pattern of fig. 12 and fig. 13)

### Notes

- For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP372..H, TSOP374..H.
- Best choice of AGC for some popular IR-codes:
  - TSOP37336H: MCIR, RCMM
  - TSOP37538H: Mitsubishi, RECS-80 Code
  - TSOP37338H: XMP-1, XMP-2, r-map

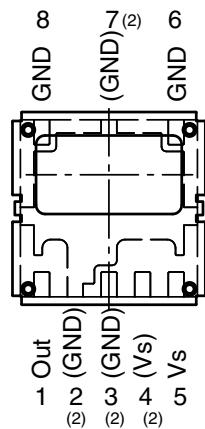
**PACKAGE DIMENSIONS** in millimeters



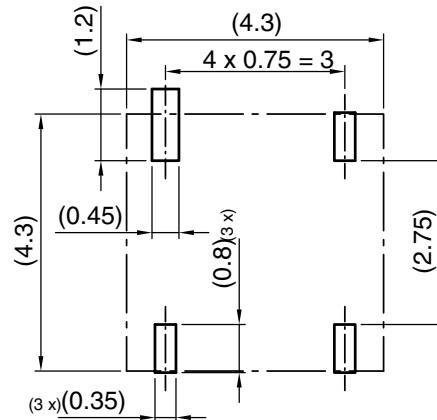
Drawing refers to following types: TSOP37...H / TSOP57...H  
Drawing-No.: 6.550-5316.01-4  
Issue: 2; 12.02.14

(2) Pins connected internally.  
It is not necessary to connect externally.

## Pinning from Topview



Proposed pad layout from  
component side  
(dim. for reference only)



## ASSEMBLY INSTRUCTIONS

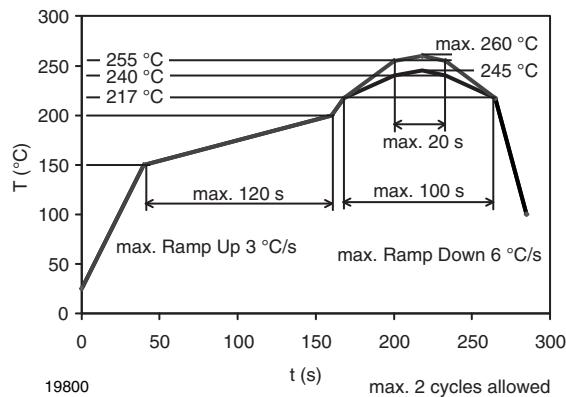
### Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

### Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

### VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



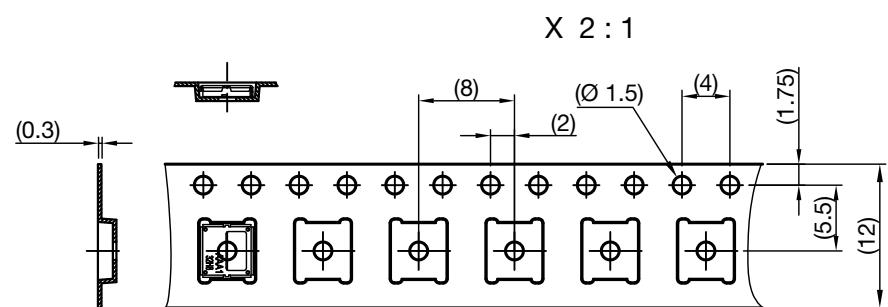
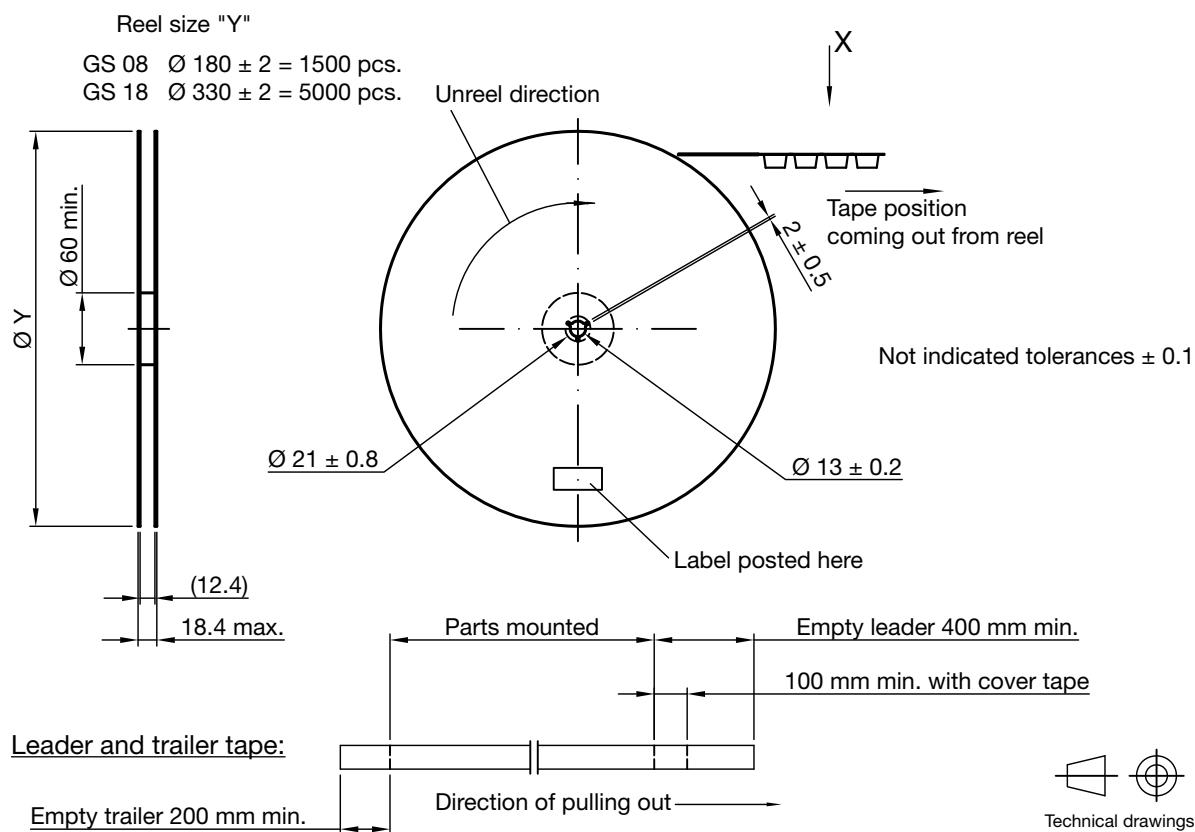
### ORDERING INFORMATION

ORDERING CODE	PACKAGING	VOLUME <sup>(1)</sup>	REMARKS
TSOP37..HTT1	Tape and reel	MOQ: 1500 pcs	3.95 mm x 3.95 mm x 0.75 mm
TSOP37..HTT2		MOQ: 5000 pcs	

#### Note

<sup>(1)</sup> MOQ: minimum order quantity

**TAPING VERSION TSOP37..H DIMENSIONS** in millimeters

Tape and Reel dimensions:


Reel dimensions and tape

Drawing-No.: 9.700-5380.01-4  
Issue: 1; 28.10.13

## LABEL

### Standard bar code labels for finished goods

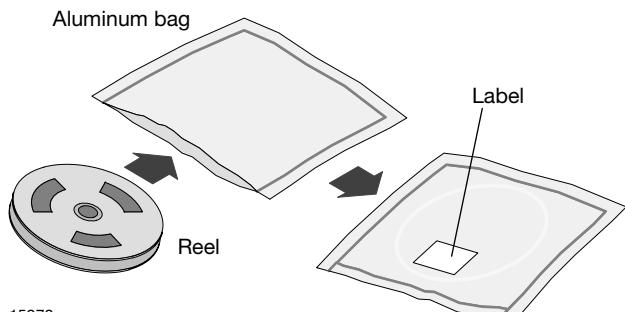
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled

with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

<b>VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL</b> (Finished goods)		
<b>PLAIN WRITING</b>	<b>ABBREVIATION</b>	<b>LENGTH</b>
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxxx+	Company logo
<b>Long bar code top</b>	<b>Type</b>	<b>Length</b>
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
<b>Short bar code bottom</b>	<b>Type</b>	<b>Length</b>
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

## DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

## FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

## RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

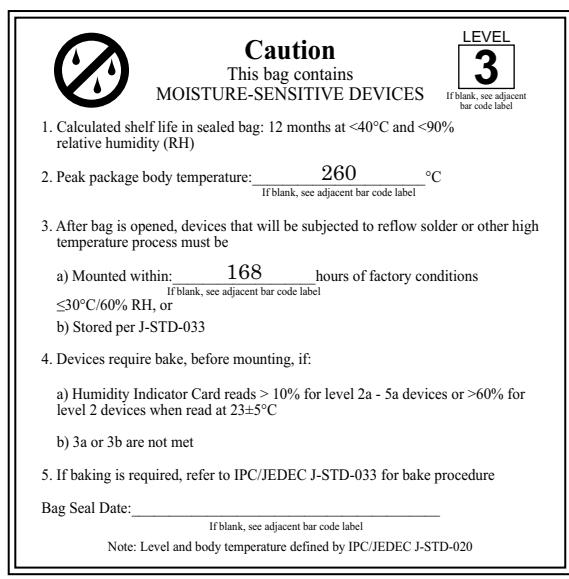
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 3 label is included on all dry bags.



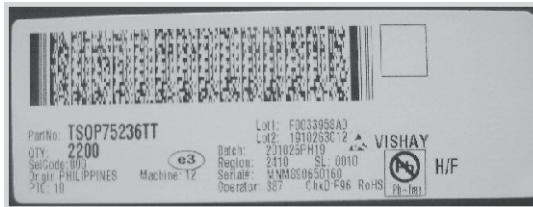
22650

EIA JEDEC standard J-STD-020 level 3 label is included  
on all dry bags

### **VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

### **BAR CODE PRODUCT LABEL (Example)**



### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

## Disclaimer

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**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

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